

公司型号	封装形式	H	包装规格	条管装-盒装：每管80Pcs，每盒4Kpcs 载带卷盘包装：每卷2500Pcs，每盒1卷盘
H01P13D H01P13K	DPAK TO-252	HAOHAI		

DESCRIPTION
 The H01P13D (H01P13K) uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

GENERAL FEATURES
 $I_D = -13A$, $V_{DS} = -100V$
 $R_{DS(ON)} < 200m\Omega$ @ $V_{GS} = 10V$ (Typ: 170m Ω)
 High density cell design for ultra low $R_{DS(ON)}$
 Fully characterized Avalanche voltage and current
 Good stability and uniformity with high EAS
 Excellent package for good heat dissipation
 Special process technology for high ESD capability
 100% UIS TESTED ! 100% ΔV_{DS} TESTED !

Application
 Power switching application
 Hard Switched and High Frequency Circuits
 Uninterruptible Power Supply

$I_D = -13A$
 $V_{DS} = -100V$
 $R_{DS(on)} = 170m\Omega$

H01P13D Series Pin Assignment

2-Lead Plastic TO-252
 Package Code: D
 Pin 1: Gate
 Pin 2: Drain
 Pin 3: Source

SMD
 DPAK
 TO-252-2L

Series Symbol:

Absolute Maximum Ratings ($T_C = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	± 20	
Drain Current-Continuous ($T_C = 25^\circ C$)	I_D	-13	A
Drain Current-Continuous ($T_C = 100^\circ C$)		-9.2	
Pulsed Drain Current		I_{DM}	
Maximum Power Dissipation	P_D	40	W
Derating factor		0.32	W/ $^\circ C$
Single pulse avalanche energy (Note 5)	E_{AS}	110	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150	$^\circ C$

Thermal Characteristic

Parameter	Symbol	Limit	Unit
Thermal Resistance, Junction-to-Case (Note 2)	$R_{\theta JC}$	3.13	$^\circ C/W$

■ Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
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■ Off Characteristics

Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-100	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V, V _{GS} =0V	--	--	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	--	--	±10	nA

■ On Characteristics (Note 3)

Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.9	-3	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-16A	--	170	200	mΩ
Forward Transconductance	g _{FS}	V _{DS} =-15V, I _D =-5A	12	--	--	S

■ On Characteristics (Note 4)

Input Capacitance	C _{iss}	V _{DS} =-25V V _{GS} =0V F=1.0MHz	--	1055	--	pF
Output Capacitance	C _{oss}		--	65	--	
Reverse Transfer Capacitance	C _{rss}		--	41	--	

■ Switching Characteristics (Note 4)

Turn-on Delay Time	t _{d(on)}	V _{DD} =-50V I _D =-10A V _{GS} =-10V R _{GEN} =9.1Ω	--	14	--	nS
Turn-on Rise Time	t _r		--	18	--	
Turn-Off Delay Time	t _{d(off)}		--	50	--	
Turn-Off Fall Time	t _f		--	18	--	
Total Gate Charge	Q _g	V _{DS} =-50V I _D =-10A V _{GS} =-10V	--	25	--	nC
Gate-Source Charge	Q _{gs}		--	5	--	
Gate-Drain Charge	Q _{gd}		--	7	--	

■ Drain-Source Diode Characteristics

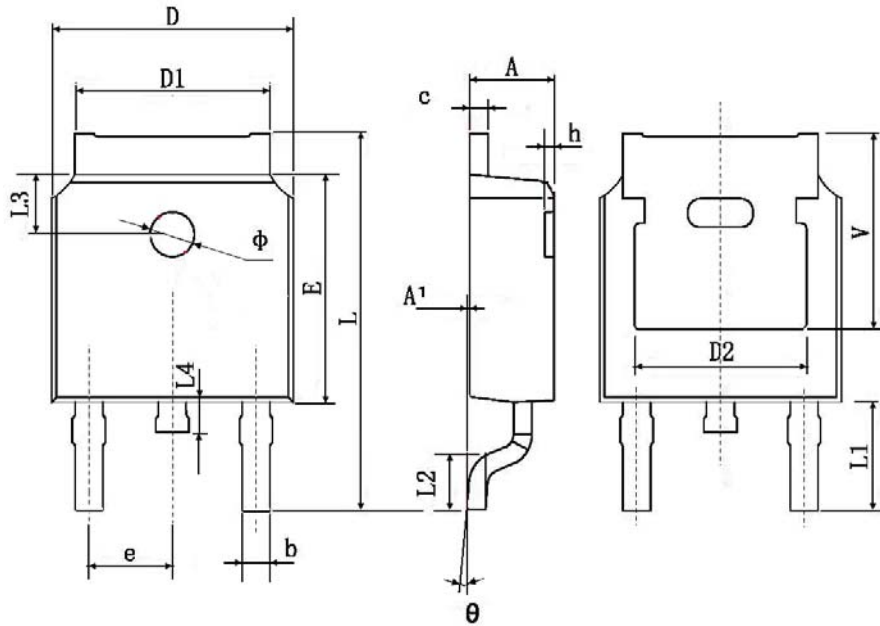
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V, I _S =-10A	--	--	-1.2	V
Diode Forward Current (Note 2)	I _S	--	--	--	-13	A
Reverse Recovery Time	t _{rr}	T _J =25°C, I _F =-10A di/dt=100A/μs (Note3)	--	35	--	nS
Reverse Recovery Charge	Q _{rr}		--	46	--	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

- 1、Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2、Surface Mounted on FR4 Board, t ≤ 10sec.
- 3、Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%
- 4、Guaranteed by design, not subject to production
- 5、EAS condition: T_J=25°C, V_{DD}=-50V, V_G=-10V, L=0.5mH, R_G=25Ω

PACKAGE DIMENSIONS

■ TO-252-2L (DPAK) PACKAGE INFORMATION (TO-252封装尺寸数据)



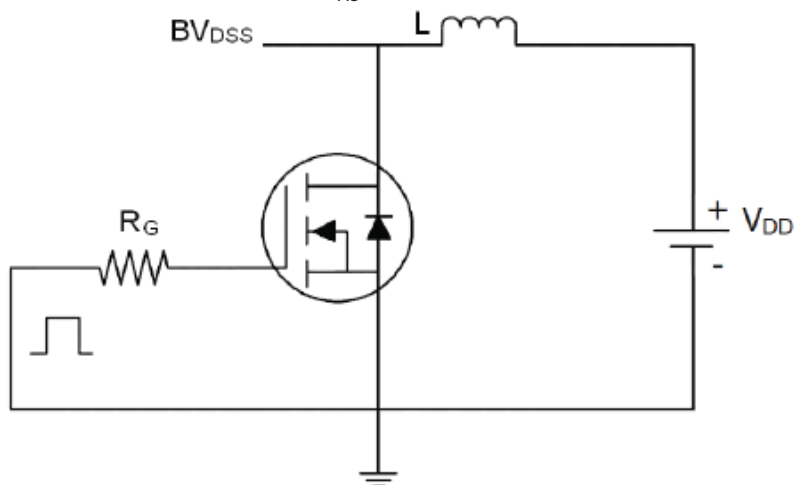
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.188	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1				
L2	1.400	1.700	0.055	0.067
L3	2.900 REF.		0.114 REF.	
L4	0.600	1.000	0.024	0.039
φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	

■ 包装规格 Packaging Specifications

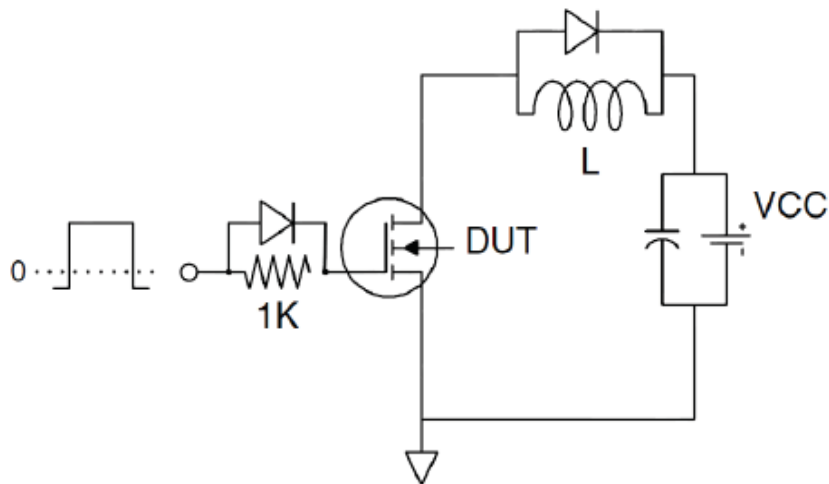
TO-252 DPAK	一、管装，每管80只，每盒4000只，每箱40000只 (80Pcs/Tub, 4Kpcs/BOX, 40Kpcs/Carton)
	二、载带卷盘包装，每卷盘2500只，每盒1卷盘，每箱25000只 (2.5Kpcs/Reel, 25Kpcs/Carton)

Test circuit

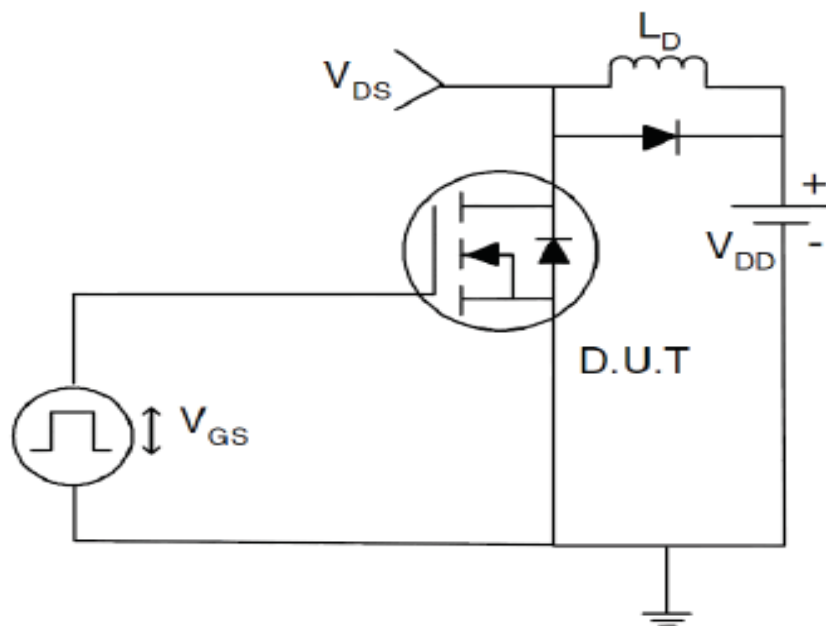
1: E_{AS} test Circuits



2: Gate charge test Circuit:



3: Switch Time Test Circuit



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

Fig-1: Output Characteristics

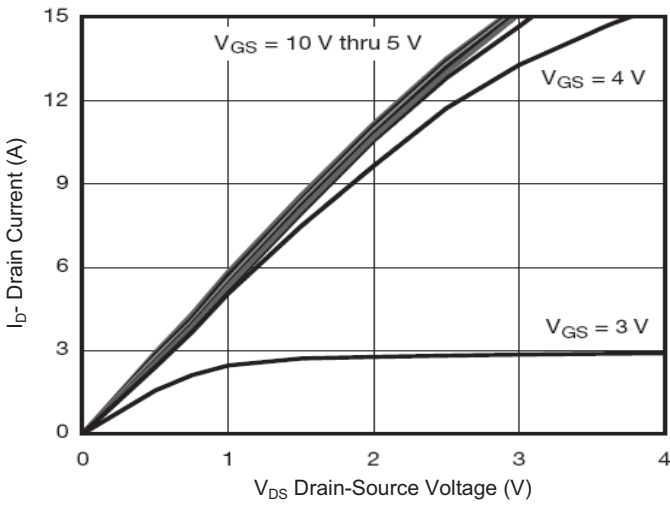


Fig-4: $R_{DS(ON)}$ -Junction Temperature

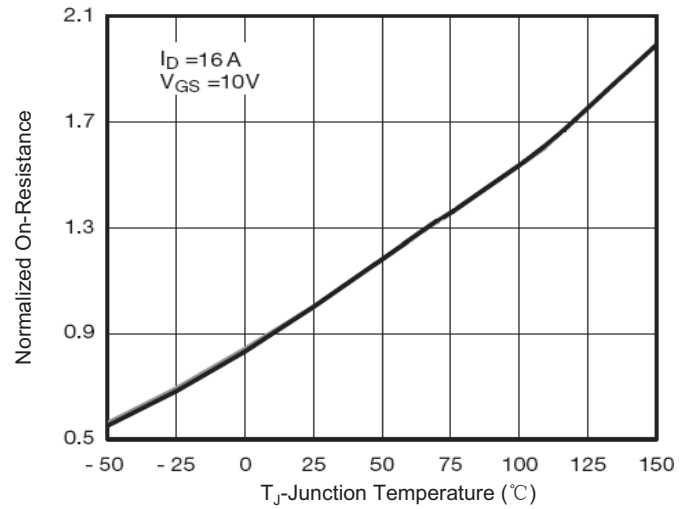


Fig-2: Transfer Characteristics

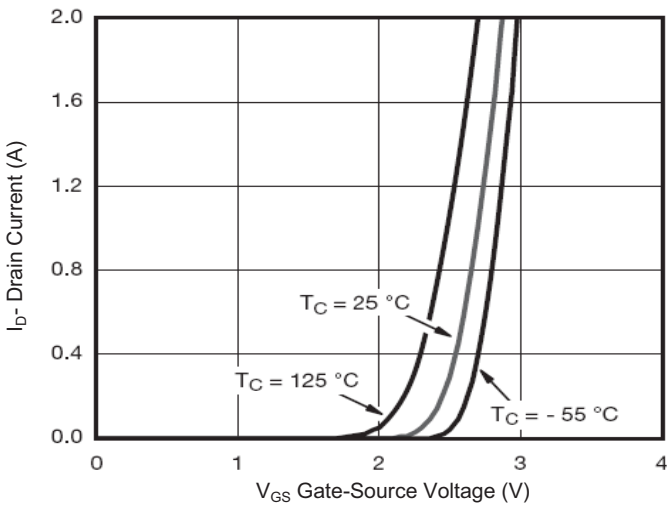


Fig-5: Gate Charge

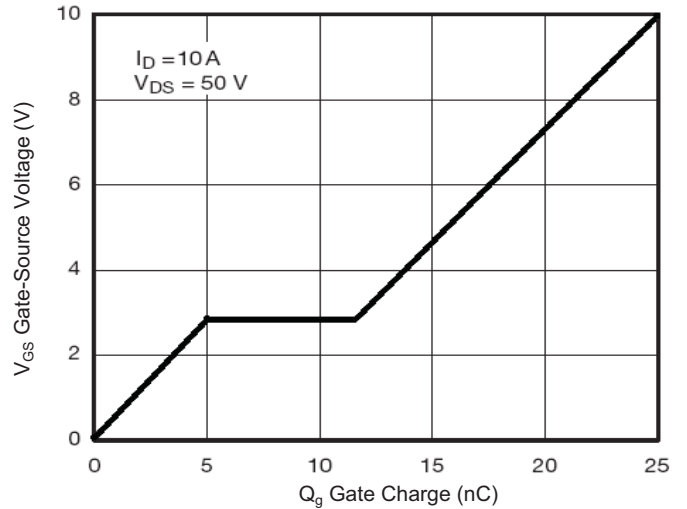


Fig-3: $R_{DS(ON)}$ - Drain Current

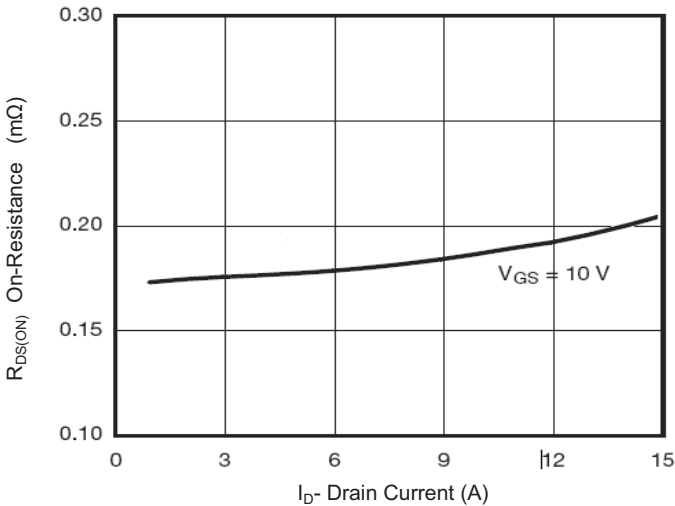


Fig-6: Source- Drain Diode Forward

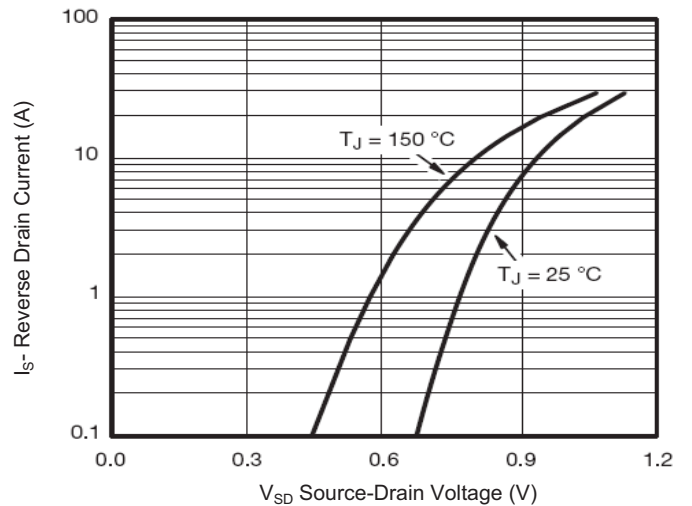


Fig-7: Capacitance vs V_{DS}

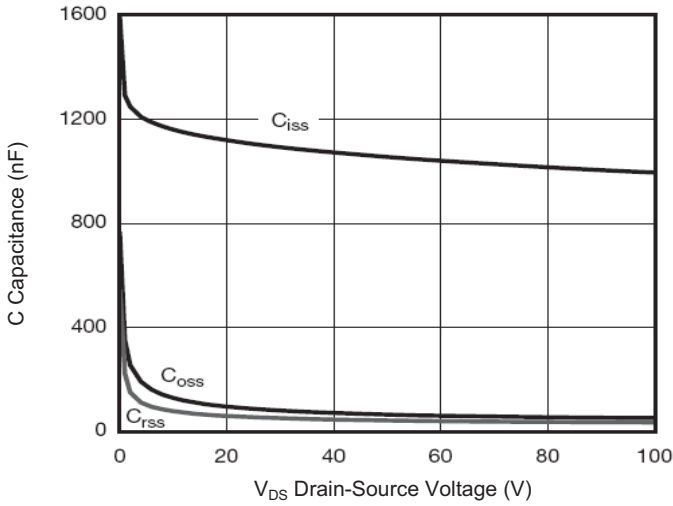


Fig-9: BV_{DSS} vs Junction Temperature

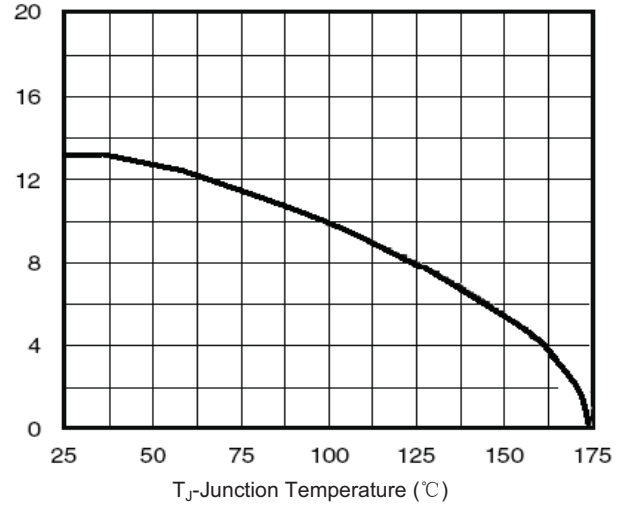


Fig-8: Safe Operation Area

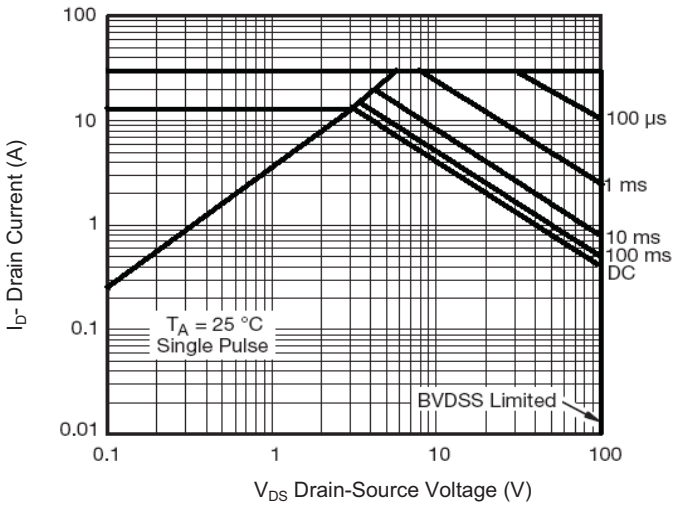


Fig-10: Power De-rating

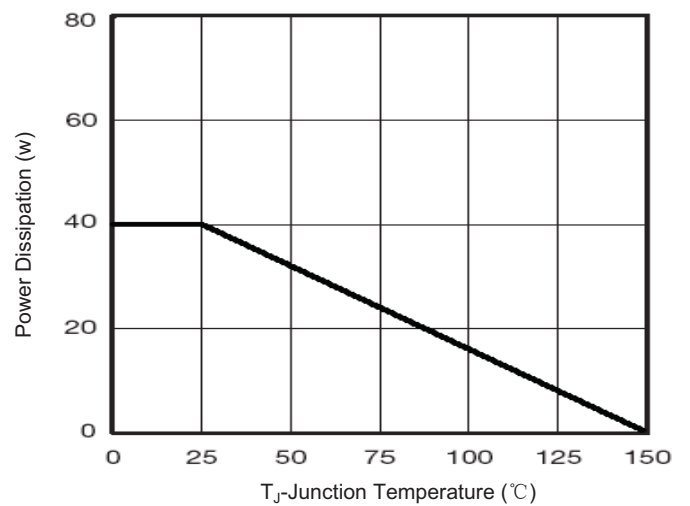
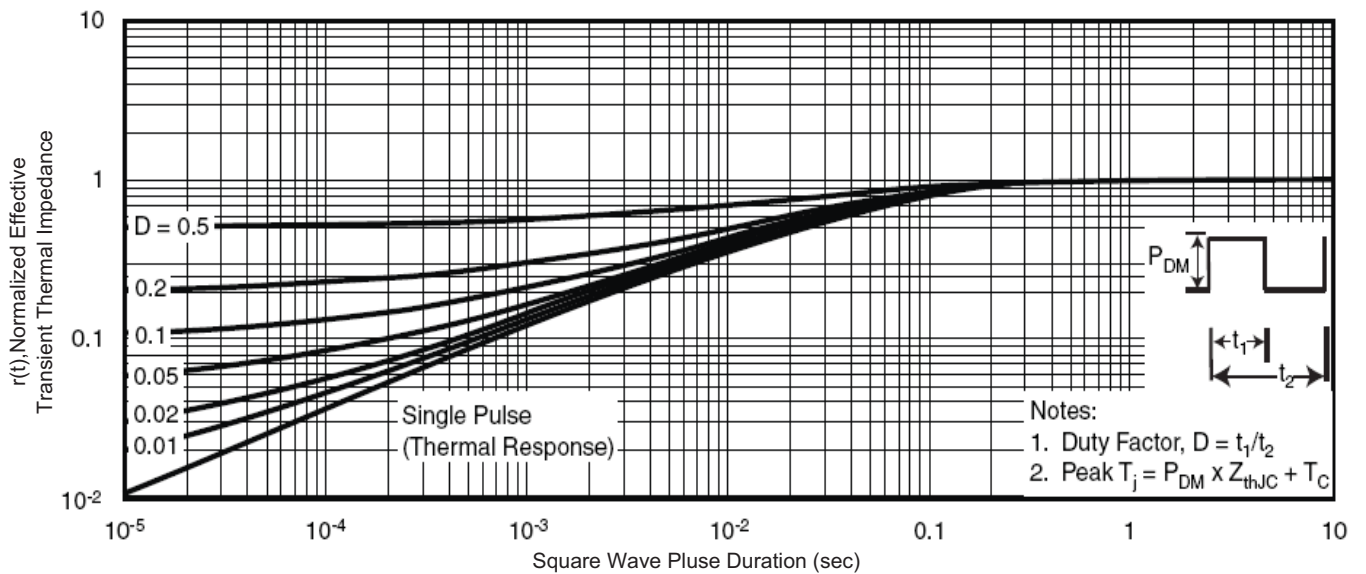


Fig-11: Normalized Maximum Transient Thermal Impedance



Manufacturers version information

2012-03-13 , HAOHAI™ Product Data-1.0

2014-03-13 , HAOHAI™ Product Data-2.0



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深圳市浩海电子有限公司

SHENZHEN HAOHAI ELECTRONICS CO., LTD.

2 floor(whole floor), BAOXIN Building. 0 Lane on the 8th. Yufeng Garden.
82 District. BAOAN District, Shenzhen City, Guangdong Province, China.

公司电话 TEL: +86-755-29955080、29955081、29955082、29955083

总机八线 TEL: +86-755-29955090、29955091、29955092、29955093

FAX: +86-755-27801767

E-mail:kkg@kkg.com.cn

<http://www.szhhe.com>

<http://www.kkg.com.cn>